# SURFACE MOUNT GLASS PASSIVATED BRIDEG RECTIFIERS

REVERSE VOLTAGE - 50 to 1000 Volts FORWARD CURRENT - 1.0 Amperes

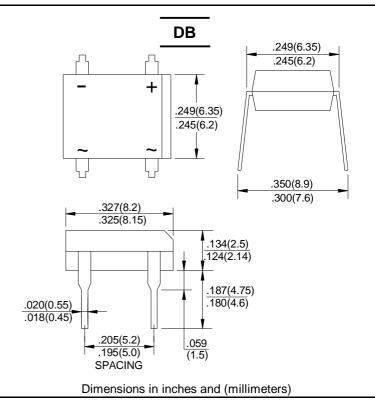
#### **FEATURES**

- ●Rating to 1000V PRV
- ●Ideal for printed circuit board
- Low forward voltage drop, high current capability
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- ●Lead tin Pb/Sn copper
- The plastic material has UL flammability classification 94V-0

### **MECHANICAL DATA**

Polarit: As marked on BodyWeight: 0.02 ounces,0.38 gras

Mounting position: Any



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave ,60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

roi capacitive load, derate current by 20%									
CHARACTERISTICS	SYMBOL	DB101	DB102	DB103	DB104	DB105	DB106	DB107	UNIT
Maximum Recurrent Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	٧
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @Ta=40°C	I(AV)	1.0							А
Peak Forward Surage Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC .Method)	lfsм	60							Α
Maximum Forward Voltage at 2.0A DC	VF	1.1							V
Maximum DC Reverse Current @TJ=25°C at Rated DC Blocking Voltage @TJ=125°C	lR	10 500							uA
I <sup>2</sup> t Rating for Fusing (t<8.3ms)	l <sup>2</sup> t	10.4							$A^2s$
Typical Junction capacitance Per Element(Note1)	CJ	25							pF
Typical Thermal Resistance (Note2)	Rejc	40							°C/W
Operating Temperature Range	TJ	-55 to +150							$^{\circ}\!\mathbb{C}$
Storage Temperature Range	Tstg	-55 to +150							$^{\circ}\!\mathbb{C}$

Note:1.Measured at 1.0MHz and applied reverse voltage of 4.0V DC

2.Thermal resistance from junction to ambient mounted on P.C.B with 0.5\*0.5"(13\*13mm) copper pads.

## RATING AND CHARACTERISTIC CURVES DB101 thru DB107

